NOT RECOMMENDED FOR NEW DESIGN

NEW DESIGN SC1454 Dual 150mA Ultra Low Dropout, Low Noise Regulator

POWER MANAGEMENT

Description

The SC1454 contains two ultra low dropout voltage regulators (ULDOs). It operates from an input voltage range of 2.25V to 6.5V, and a wide variety of output voltage options are available. One ULDO has a fixed output, and the other is either fixed (SETA pin grounded) or adjustable using external resistors. Each ULDO has an independent enable pin.

The SC1454 has a bypass pin to enable the user to capacitively decouple the bandgap reference for very low output noise ($50\mu V_{RMS}$ typically).

Designed specifically for battery operated systems, the devices utilize CMOS technology to require very low operating currents (typically 130µA with both outputs supplying 150mA). In addition, the dropout voltage is typically 155mV at 150mA, helping to prolong battery life further. The devices are designed to provide 400mA of peak current for applications which require high initial inrush current.

They have been designed to be used with low ESR ceramic capacitors to save cost and PCB area.

The SC1454 is available with a wide variety of voltage options as standard. It comes in the tiny 8 lead MSOP surface mount package.

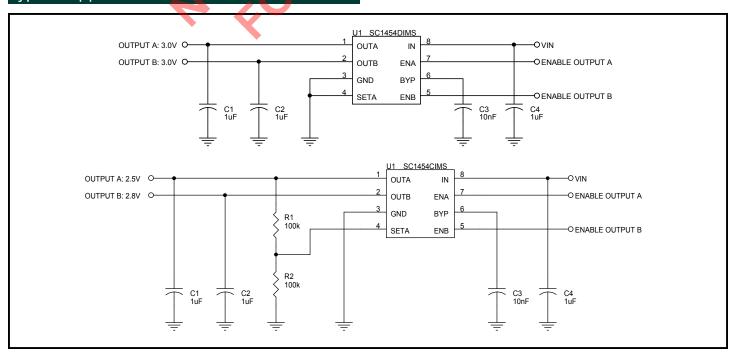
Features

- Up to 150mA per regulator output
- Low quiescent current
- ◆ Low dropout voltage
- ◆ Stable operation with ceramic caps
- Very low 50μV_{RMS} output noise
- Wide selection of output voltages
- ◆ Tight load and line regulation
- Current and thermal limiting
- ◆ Reverse input polarity protection
- ◆ <1.5uA off-mode current
- ◆ Logic controlled enable

Applications

- ◆ Cellular telephones
- ◆ Palmtop/Laptop computers
- ◆ Battery-powered equipment
- Bar code scanners
- SMPS post regulator/dc to dc modules
- High efficiency linear power supplies

Typical Application Circuit



Absolute Maximum Ratings

Exceeding the specifications below may result in permanent damage to the device, or device malfunction. Operation outside of the parameters specified in the Electrical Characteristics section is not implied. Exposure to Absolute Maximum rated conditions for extended periods of time may affect device reliability.

Parameter	Symbol	Maximum	Units
Input Supply Voltage	V _{IN}	-5 to +7	V
Enable Input Voltage	V _{EN}	-5 to +V _{IN}	V
Operating Ambient Temperature Range	T _A	-40 to +85	°C
Operating Junction Temperature Range	T _J	-40 to +125	°C
Storage Temperature Range	T _{STG}	-60 to +150	°C
Thermal Impedance Junction to Ambient(1)	θ_{JA}	206	°C/W
Thermal Impedance Junction to Ambient ⁽²⁾	θ_{JA}	95	°C/W
Thermal Impedance Junction to Case	θ_{JC}	39	°C/W
ESD Rating (Human Body Model)	ESD	2	kV

Notes:

- (1) Minimum pad size.
- (2) 1 square inch of FR-4, double sided, 1oz. minimum copper weight.

Electrical Characteristics

Unless specified: $T_A = 25^{\circ}\text{C}$, $V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$, $I_{\text{OUTA}} = I_{\text{OUTB}} = 1\text{mA}$, $C_{\text{IN}} = C_{\text{OUT}} = 1.0 \,\mu\text{F}$, $V_{\text{ENA}} = V_{\text{ENB}} = V_{\text{IN}}$. Values in **bold** apply over full operating temperature range.

Parameter	Symbol	Conditions	Min	Тур	Max	Units
IN		6.7		,		
Input Supply Voltage	V _{IN}	2	2.25		6.50	V
Quiescent Current	I _Q	$V_{\text{ENA}} = 0\text{V}, V_{\text{ENB}} = V_{\text{IN}}, I_{\text{OUTB}} = 150\text{mA} \text{ or}$		100	150	μA
		V _{ENB} = 0V, V _{ENA} = V _{IN} , I _{OUTA} = 150mA			200	
		$V_{ENA} = V_{ENB} = V_{IN}$, $I_{OUTA} = I_{OUTB} = 150$ mA		130	200	μA
					250	
		$V_{IN} = 6.5V, V_{ENA} = V_{ENB} = 0V (OFF)$		0.2	1.0	μA
					1.5	
OUTA, OUTB						-
Output Voltage ⁽¹⁾	V _{out}	I _{OUT} = 1mA	-1%	V _{OUT}	+1%	V
		$0\text{mA} \le I_{\text{OUT}} \le 150\text{mA}, V_{\text{OUT}} + 1V \le V_{\text{IN}} \le 5.5V$	-2%		+2%	
Line Regulation ⁽¹⁾	REG _(LINE)	V_{OUT} + 1V \leq V_{IN} \leq 5.5V, I_{OUT} = 1mA		2.5	10	mV
					12	
Load Regulation ⁽¹⁾	REG _(LOAD)	$0.1\text{mA} \le I_{\text{OUT}} \le 150\text{mA}$		-5	-20	mV
					-30	

Electrical Characteristics

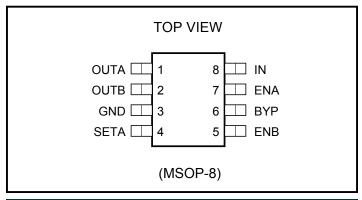
Unless specified: T_A = 25°C, V_{IN} = V_{OUT} + 1V, I_{OUTA} = I_{OUTB} = 1mA, C_{IN} = C_{OUT} = 1.0 μ F, V_{ENA} = V_{ENB} = V_{IN} . Values in **bold** apply over full operating temperature range.

Parameter	Symbol	Conditions	Min	Тур	Max	Units
OUTA, OUTB (Cont.)						
Dropout Voltage(1)(2)	V _D	I _{OUT} = 1mA		1		mV
		I _{out} = 50mA		52	70	
					90	
		I _{OUT} = 150mA		155	210	
					270	
Current Limit	I _{LIM}		400			mA
Ripple Rejection	PSRR	f = 120Hz, C _{BYP} = 10nF		61		dB
Output Voltage Noise	e _n	f = 10Hz to 100kHz, I_{OUT} =50mA, C_{BYP} = 10nF, C_{OUT} = 2.2µF, 1.8V output		27		μV_{RMS}
		f = 10Hz to 100kHz, I_{OUT} =50mA, C_{BYP} = 10nF, C_{OUT} = 2.2 μ F, 3.3 V output		55		
ENA, ENB		-0,.0,				
Enable Input Threshold	V _{IH}	N. U.	1.6			V
	V _L				0.4	
Enable Input Bias Current(3)	I _{EN}	$0V \le V_{ENA/B} \le V_{IN}$	-0.5		0.5	μΑ
ВҮР						
Start-Up Rise Time	ţ	C _{BYP} = 10nF		1.25		ms
SETA						
Sense/Select Threshold	V_{TH}		20	40	80	mV
SETA Reference Voltage	V _{SETA}	$V_{IN} = 2.5V$, $I_{OUT} = 1mA$	-1%	1.250	+1%	V
		$0\text{mA} \leq \text{I}_{\text{OUT}} \leq 150\text{mA}, 2.5\text{V} \leq \text{V}_{\text{IN}} \leq 5.5\text{V}$	-2%		+2%	
SETA Input Leakage Current ⁽³⁾	I _{SETA}	V _{SETA} = 1.3V		0.015	50	nA
Over Temperature Protection						
High Trip Level	T _{HI}			150		°C
Hysteresis	T _{HYST}			20		°C

NOTES:

- (1) Low duty cycle pulse testing with Kelvin connections required.
- (2) Defined as the input to output differential at which the output drops 100mV below the value measured at a differential of 1V. Not measurable on outputs less than 2.25V due to minimum V_{IN} constraints.
- (3) Guaranteed by design.

Pin Configuration



Ordering Information		
Part Numbers	Package	
SC1454XIMSTR ⁽¹⁾⁽²⁾		
SC1454XIMSTRT ⁽¹⁾⁽²⁾⁽³⁾ MSOP-8		

Notes:

- (1) Where X denotes voltage options see Voltage Options table.
- (2) Only available in tape and reel packaging. A reel contains 2500 devices.
- (3) Lead free product. This product is fully WEEE and RoHS compliant.

Voltage Options

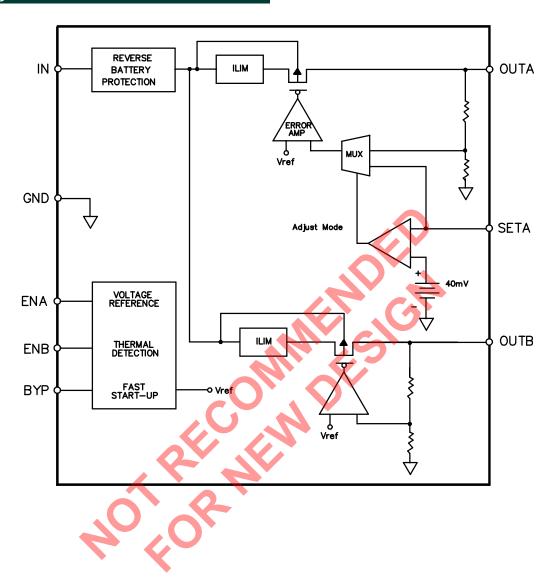
Replace X in the part number (SC1454XIMS) by the letter shown below for the corresponding voltage option:

Х	V _{OUTA} (V)	V _{OUTB} (V)
Α	1.8	1.8
В	2.5	2.5
С	2.8	2.8
D	3.0	3.0
E	3.3	3.3
F	3.0	2.5
G	3.0	1.8
Í	3.0	2.8
J	3.3	2.5
K	3.3	2.8

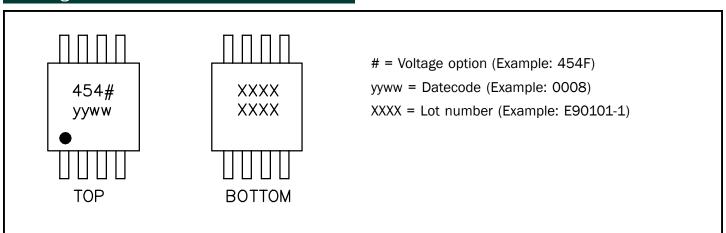
Pin Descriptions

Pin #	Pin Name	Pin Function
1	OUTA	Regulator A output.
2	OUTB	Regulator B output.
3	GND	Ground pin.
4	SETA	Connecting this pin to ground results in the internally preset value for $V_{OUT.}$ Connecting to an external resistor divider changes V_{OUTA} to: $V_{OUTA} = 1.250 \bullet \left(1 + \frac{R1}{R2}\right)$
5	ENB	Active high enable pin for output B. CMOS compatible input. Connect to IN if not being used.
6	ВҮР	Bypass pin for bandgap reference. Connect a 10nF capacitor, $C_{\rm BYP}$, between this pin and ground for low noise operation.
7	ENA	Active high enable pin for output A. CMOS compatible input. Connect to IN if not being used.
8	IN	Input pin for both regulators.

Block Diagram



Marking Information



Applications Information

Theory Of Operation

The SC1454 is intended for applications where very low dropout voltage, low supply current and low output noise are critical. Furthermore, the SC1454, by combining two ultra low dropout (ULDO) regulators, along with enable controls and output voltage adjustability for one output, provides a very space efficient solution for multiple supply requirements.

The SC1454 contains two ULDOs, both of which are supplied by one input supply, between IN and GND. Each ULDO has its own active high enable pin (ENA/ENB). Pulling this pin low causes that specific ULDO to enter a very low power shutdown state.

The SC1454 contains an internal bandgap reference which is fed into the inverting input of two error amplifiers, one for each output. The output voltage of each regulator is divided down internally using a resistor divider and compared to the bandgap voltage. The error amplifier drives the gate of a low $R_{\rm DS(ON)}$ P-channel MOSFET pass device.

Output A has both a fixed and adjustable output voltage mode. Grounding the SETA pin (pulling it below the Sense/Select threshold of 40mV) will connect the internal resistor divider to the error amplifier resulting with the internally preset output voltage. If SETA is pulled above this threshold, then the Sense/Select switch will connect the SETA pin to the error amplifier. Output A will then be regulated such that the voltage at SETA will equal V_{SETA} , the SETA reference voltage (typically 1.250V).

A bypass pin (BYP) is provided to decouple the bandgap reference to reduce output noise (on both outputs) and also to improve power supply rejection.

Each regulator has its own current limit circuitry to ensure that the output current will not damage the device during output short, overload or start-up. The current limit is guaranteed to be greater than 400mA to allow fast charging of the output capacitor and high initial currents for DSP initialization.

The SC1454 has a fast start-up circuit to speed up the initial charging time of the bypass capacitor to enable the output voltage to come up quicker.

The SC1454 includes thermal shutdown circuitry to turn off the device if T_j exceeds 150°C (typical), with the device remaining off until T_j drops by 20°C (typical). Reverse battery protection circuitry ensures that the device cannot be damaged if the input supply is accidentally reversed, limiting the reverse current to less than 1.5mA.

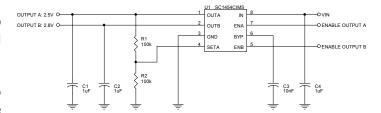
Component Selection - General

Output capacitor - Semtech recommends a minimum capacitance of 1µF at the output with an equivalent series resistance (ESR) of < 1 Ω over temperature. While the SC1454 has been designed to be used with ceramic capacitors, it does not have to be used with ceramic capacitors, allowing the designer a choice. Increasing the bulk capacitance will further reduce output noise and improve the overall transient response.

Input capacitor - Semtech recommends the use of a 1µF ceramic capacitor at the input. This allows for the device being some distance from any bulk capacitance on the rail. Additionally, input droop due to load transients is reduced, improving overall load transient response.

Bypass capacitor - Semtech recommends the use of a 10nF ceramic capacitor to bypass the bandgap reference. Increasing this capacitor to 100nF will further improve power supply rejection. Reducing this capacitor below 1nF may result in output overshoot at turn-on.

Component Selection - Externally Setting Output



Referring to the circuit above, the output voltage of output A can be externally adjusted anywhere within the range from 1.25V to $(V_{\text{IN(MAX)}} - V_{\text{D(MAX)}})$. The output voltage will be in accordance with the following equation:

$$V_{OUTA} = 1.250 \bullet \left(1 + \frac{R1}{R2}\right)$$

1% tolerance resistors are recommended. The values of

Applications Information (Cont.)

R1 and R2 should be selected such that the current flowing through them is $\geq 10\mu A$ (thus R2 $\leq 120k\Omega$).

Thermal Considerations

The worst-case power dissipation for this part is given by:

$$P_{D(MAX)} = (V_{IN(MAX)} - V_{OUTA (MIN)}) \bullet I_{OUTA (MAX)} + (V_{IN(MAX)} - V_{OUTB (MIN)}) \bullet I_{OUTB (MAX)} + V_{IN(MAX)} \bullet I_{Q(MAX)}$$

$$(1)$$

For all practical purposes, equation (1) can be reduced to the following expression:

$$P_{D(MAX)} = (V_{IN(MAX)} - V_{OUTA (MIN)}) \bullet I_{OUTA (MAX)} + (V_{IN(MAX)} - V_{OUTB (MIN)}) \bullet I_{OUTB (MAX)}$$
(2

Looking at a typical application:

$$\begin{array}{l} {\rm V_{IN(MAX)}} = 4.2 {\rm V} \\ {\rm V_{OUTA}} = 3 {\rm V} \cdot 2 {\rm W} \; (worst\; case) = 2.94 {\rm V} \\ {\rm V_{OUTB}} = 3.3 {\rm V} \cdot 2 {\rm W} \; (worst\; case) = 3.234 {\rm V} \\ {\rm I_{OUTA}} = {\rm I_{OUTB}} = 150 {\rm mA} \\ {\rm T_A} = 85\,{\rm ^{\circ}C} \end{array}$$

Inserting these values into equation (2) above gives us:

$$P_{D(MAX)} = (4.2 - 2.94) \bullet 0.15 + (4.2 - 3.234) \bullet 0.15$$
$$= 0.189 + 0.145$$
$$= 0.334W$$

Using this figure, we can calculate the maximum thermal

impedance allowable to maintain T₁ ≤ 125°C:

$$\theta_{\text{JA(MAX)}} = \frac{\left(T_{\text{J(MAX)}} - T_{\text{A(MAX)}}\right)}{P_{\text{D(MAX)}}}$$
$$= \frac{\left(125 - 85\right)}{0.334}$$
$$= 120^{\circ}\text{C/W}$$

This target value can be achieved by using one square inch of board copper connected to the GND pin (pin 3), which connects directly to the device substrate. Increasing this area or the use of multi layer boards will lower the junction temperature and improve overall output voltage accuracy.

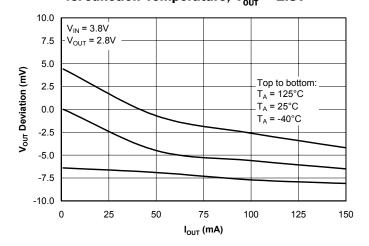
Layout Considerations

While layout for linear devices is generally not as critical as for a switching application, careful attention to detail will ensure reliable operation.

- 1) Attaching the part to a larger copper footprint will enable better heat transfer from the device, especially on PCBs where there are internal ground and power planes.
- 2) Place the input, output and bypass capacitors close to the device for optimal transient response and device behaviour.
- 3) Connect all ground connections directly to the ground plane. If there is no ground plane, connect to a common local ground point before connecting to board ground.

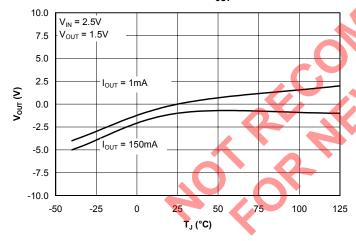
Typical Characteristics

Output Voltage vs. Output Current vs. Junction Temperature, $V_{\text{OUT}} = 2.8V$

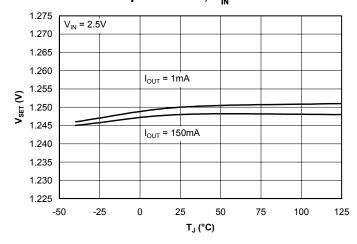


Output Voltage vs. Junction Temperature

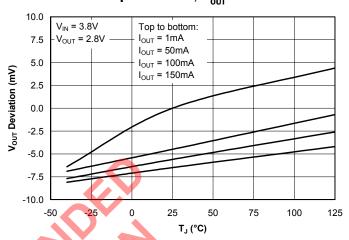
vs. Output Current, $V_{OUT} = 1.5V$



SETA Reference Voltage vs. Junction Temperature vs. Output Current, $V_{IN} = 2.5V$

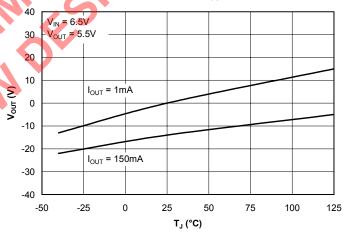


Output Voltage vs. Junction Temperature vs. Output Current, $V_{OUT} = 2.8V$



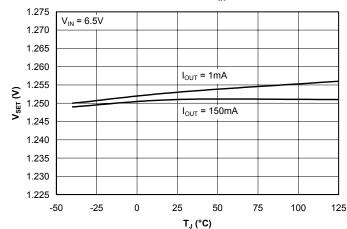
Output Voltage vs. Junction Temperature





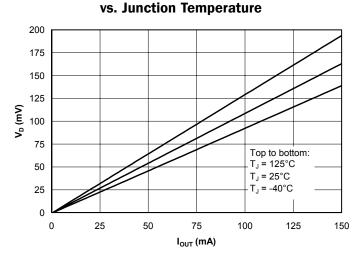
SETA Reference Voltage vs. Junction Temperature

vs. Output Current, $V_{IN} = 6.5V$



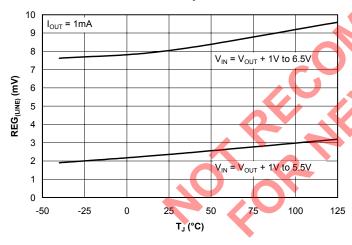
Typical Characteristics (Cont.)

Dropout Voltage vs. Output Current

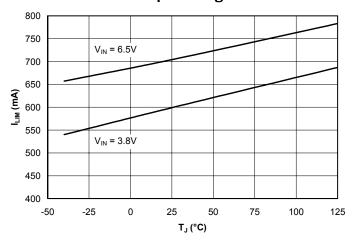


Line Regulation vs.

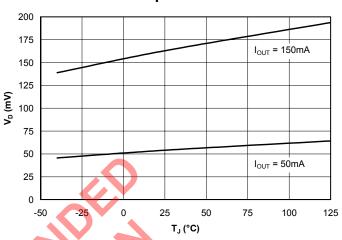
Junction Temperature



Current Limit vs. Junction Temperature vs. Input Voltage

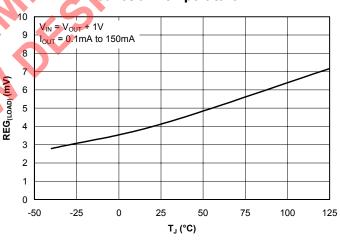


Dropout Voltage vs. Junction Temperature vs. Output Current

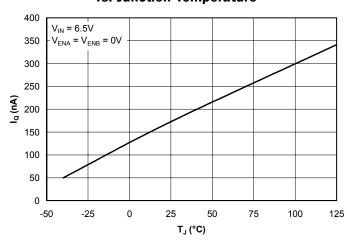


Load Regulation vs.

Junction Temperature

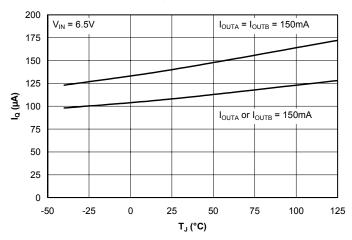


Off-State Quiescent Current vs. Junction Temperature

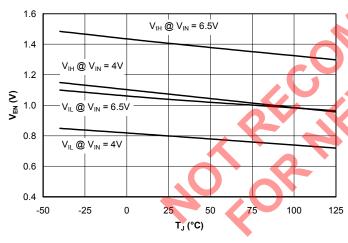


Typical Characteristics (Cont.)

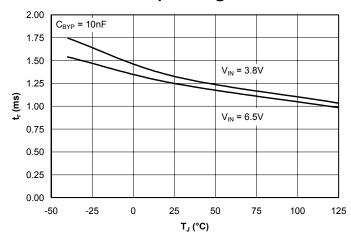
Quiescent Current vs. Junction Temperature vs. Output Current



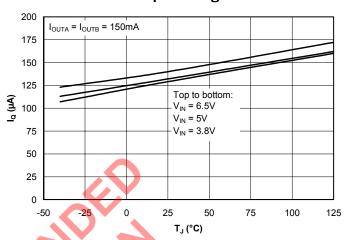
Enable Input Voltage vs. Junction Temperature vs. Input Voltage



Bypass Start-up Rise Time vs. Junction Temperature vs. Input Voltage

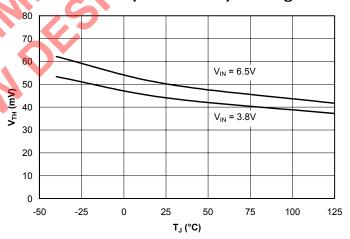


Quiescent Current vs. Junction Temperature vs. Input Voltage

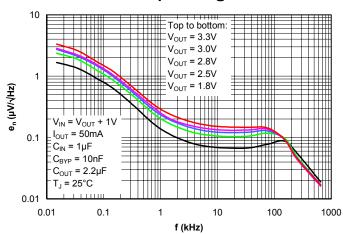


Sense/Select Threshold Voltage vs.

Junction Temperature vs. Input Voltage

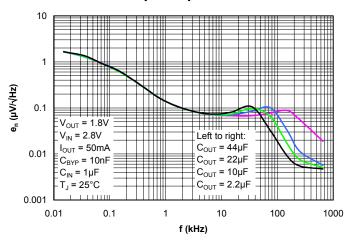


Output Spectral Noise Density vs. Frequency vs. Output Voltage

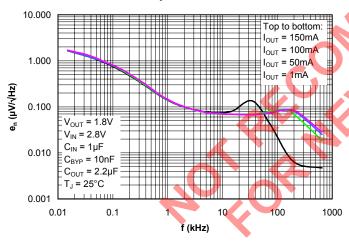


Typical Characteristics (Cont.)

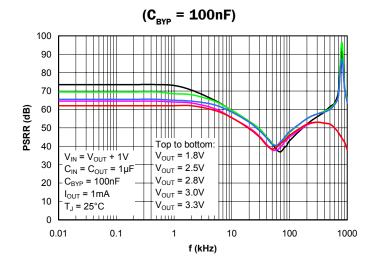
Output Spectral Noise Density vs. Frequency vs. Output Capacitance



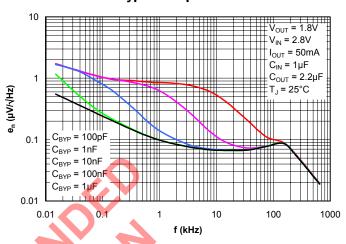
Output Spectral Noise Density vs. Frequency vs. Output Current



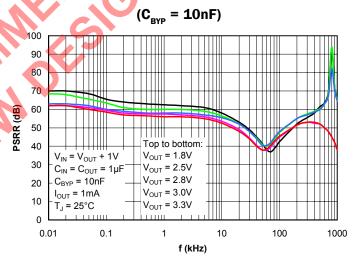
PSRR vs. Frequency vs. Output Voltage



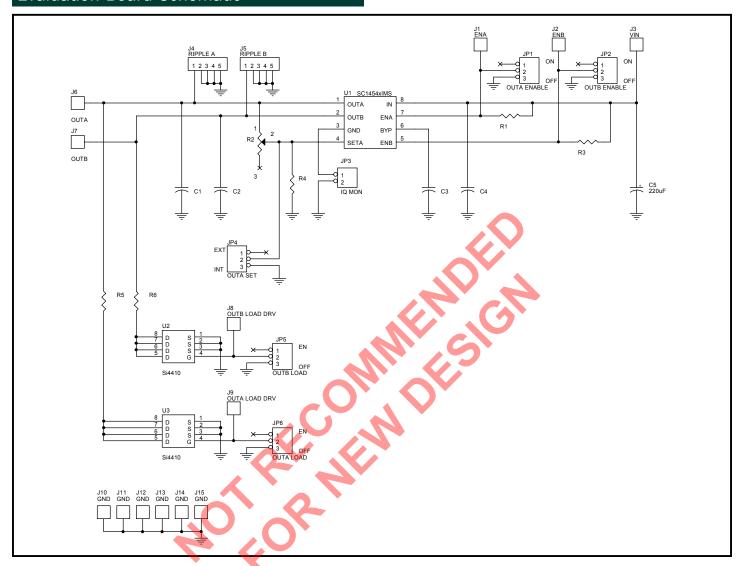
Output Spectral Noise Density vs. Frequency vs. Bypass Capacitance



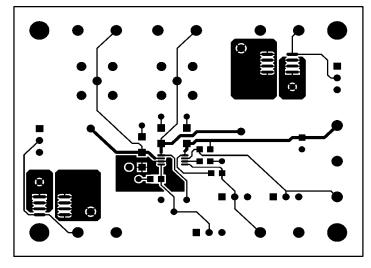
PSRR vs. Frequency vs. Output Voltage

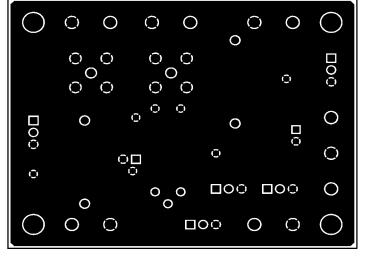


Evaluation Board Schematic



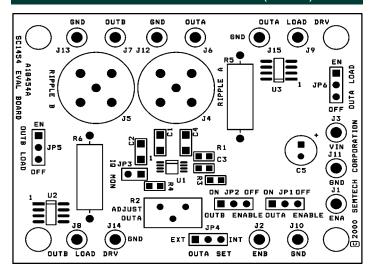
Evaluation Board Gerber Plots





Top Copper Bottom Copper

Evaluation Board Gerber Plots (Cont.)

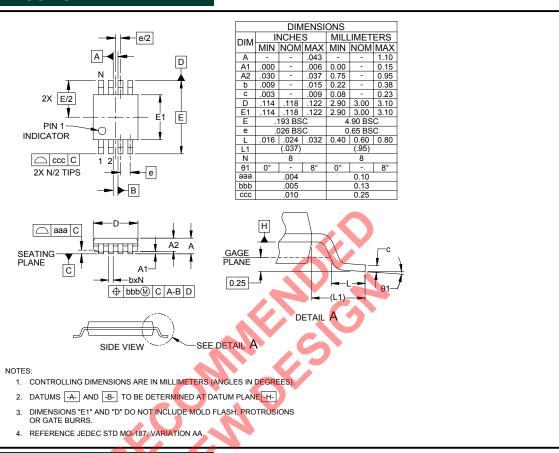


Top Assembly

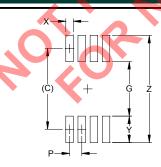
Evaluation Board Bill Of Materials

OUTB LOAD DRV	DJUST OUTB ENABLE (JP4 J2 BND EXT DUTA SET ENB	J10 00 00 00 00 00 00 00 00 00 00 00 00 0	SED.			
Top Assembly Evaluation Board Bill Of Materials						
Evaluation B	Evaluation Board Bill Of Materials					
Quantity	Reference	Part/Description	Vendor	Notes		
2	C1, C2	2.2µF ceramic	Murata	GRM42-6X7R225K16		
1	C3	10nF ceramic	Various			
1	C4	1μF ceramic	Murata	GRM42-6X7R105K25		
1	C5	220µF, 10V	Various			
2	J1, J2	Test pin	Various	White		
3	J3, J6, J7	Test pin	Various	Red		
2	J4, J5	BNC socket	Various	V _{OUT} ripple monitor		
2	J8, J9	Test pin	Various	Orange		
6	J10 - J15	Test pin	Various	Black		
5	JP1, JP2, JP4 - JF	P6 Header, 3 pin	Various			
1	JP3	Header, 2 pin	Various			
2	R1, R3	10kΩ, 1/10W	Various			
1	R2	250kΩ, 25T	Bourns	Trimmer potentiometer		
1	R4	62kΩ, 1/10W	Various			
2	R5, R6	150mA load	Various	1W, may not be same value		
1	U1	SC1454xIMS	Semtech			
2	U2, U3	Si4410	Vishay			

Outline Drawing - MSOP-8



Land Pattern - MSOP-8



DIMENSIONS			
DIM	INCHES	MILLIMETERS	
С	(.161)	(4.10)	
G	.098	2.50	
Р	.026	0.65	
Х	.016	0.40	
Υ	.063	1.60	
Ζ	.224	5.70	

NOTES:

THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR
COMPANY'S MANUFACTURING GUIDELINES ARE MET.

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